

产品规格书

SPECIFICATIONS FOR PRODUCT

产品类型 TYPE : HC-49/S

产品规格 SPEC : 12MHz/49S/20PF/30PPM

产品型号 P/N : CJ02-120002030A30L32

日期 DATE : 2020/08/02

核准及签名			部パコ
R&D APPR. SIGNATURED			DEPT.
拟制	审核	批准	频率器件事业部
ISSUE	СНЕСК	APPROVAL	
魏永鑫	许秋菊 2020/08/02	杨立新 2020/08/02	

江 苏 长 晶 科 技 有 限 公 司 JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

地址:中国江苏省南京江北新区产业技术研创园江淼路88号腾飞大厦C座13楼 Add: 13Th Floor, C Block, Tengfei Building, No. 88 Jiangmiao Rd. Pukou District, Nanjing City, Jiangsu Province, China

JSCJ

JIANGSU CHANGJING ELECTRONICS TECHNOLOGY CO., LTD

HC-49/S Quartz Crystal

CJ02-120002030A30L32

1. Scope:

This specification applies to the RoHS/SONY compliance quartz crystal unit with a frequency of 12MHz which will be used in crystal oscillator applications.

2. Construction:

2.1 Type of Quartz Resonator: HC-49/S

3. **Electrical Characteristics**

3.1 Nominal Frequency(f):

12MHz 3.2 Load Capacitance(C₁): 20pF 3.3 Frequency Tolerance($\triangle f/f$): ±30ppm 3.4 Frequency Temperature Stability: ±30ppm 3.5 Resonance Resistance(ohm): 40ohms Max 3.6 Osc mode: Fundamental mode 3.7 Shunt Capacitance(C₀): <7pF 3.8 Drive Level(D₁): <300µW 3.9 Operating Temperature Range(T_{OPR}):

-20 to + 70°C

3.10 Storage Temperature Range(T_{STG}): -55 to + 125°C

3.11 Insulation Resistance(IR): >500 M ohms

3.12 Aging($\triangle f_A$): ± 3ppm per Year

1

4. Reliability Specifications

This is the quality control and quality assurance and reliability tests performance data for the RoHS/

SONY compliance 12MHz HC-49/S Quartz Crystal.

related to the specification and approval sheet provided by JSCJ.

Standard test condition (TEMP.: 20±5°C. Relative humidity: 65±20%)

For any discrepancy in GO/NG, test will be done at TEMP.25±2°C, R.H. 65±5%.

NO.	PROCESS	SPECIFICATION	TEST METHOD
4.1	Temperature Cycle (GB/T 2423.22-2002, Method Nb)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.	taken after DUT being left at room temperature for 24±2 hours.
4.2	Low Temperature Storage (GB/T 2423.1-2001, Method Aa)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.	Spending 72 hrs at -55°C±3°C constant temperature. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.3	High Temperature Storage (GB/T 2423.2-2001, Method Ba)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.	Spending 72 hrs at 125°C±3°C constant temperature. Measurement taken after DUT being left at room temperature for 24±2 hours.
4.4	Humidity (GB/T 2423.3- 2006, Method Cab)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.	Spending 96 hrs at 40 °C \pm 3 °C, with 93 %R.H, Then keep the DUT in dry oven at 40 \pm 5 °C for 24 hour. Measurement taken after DUT being left at room temperature for 1 to 2 hours.
4.5	Vibration (GB/T 2423.10- 1995, Method Fc)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.	Apply 0.75mm vibration at sweep frequency $10\sim500$ Hz, 10 cycles in each direction of 3 axis. Measurement taken after 1 hour.
4.6	Shock (GB/T 2423.5-1995, Method Ea)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.and exhibit no visible damage.	Peak 1000m/s2, normal width 6ms half sine wave form, 3.7m/s, 3 perpendicular axis of samples, 3 cycles / direction, total 18 cycles. Measurement taken after 1 hour.
4.7	Drop (GB/T 2423.8-1995, Method Ed)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.and exhibit no visible damage.	Free drop to the steel plate with thickness of 3 mm from 1.00 m heights for 3 times.
4.8	Solderability (IEC60068-2-58,Test Td:)	Terminals shall be covered more then 95% with solder.	Passed through the re-flow oven under the following condition. Preheat 150 to 180°C for 60 to 120sec, and soldering time for 20s ± 5s at 235°C, peak soldering time for 10s ± 1s betweein 240 and 250°C. There is no need to do functional test. 8-12X magnifier.
4.9	Terminal Strength (JIS-C- 6429 Method 1 & 2)	No visible damage	Mount on a glass-epoxy board (100x50x1.6mm), then bend to 2mm displacement (velocity 1mm/sec) and keep for 5 seconds. or pulling force 1.8kg for at least 60 seconds.
4.10	Resistance to Soldering Heat (IEC60068-2-58,Test Td: Table 4)	Frequency change after test ≤± 5ppm.Resonance resistance change after test ≤10ohms.	Passed through the re-flow oven under the following condition. Preheat 150 to 180°C for 60 to 120sec, and sodering time for 60s max at 235°C, peak soldering time for 20s max at 265°C max. Measurement taken after DUT being left at room temperature for at least 2 hours.
4.11	OTHERS		

2

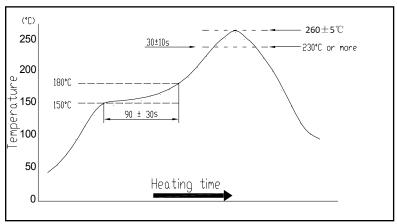
rev1.0

Recommended Reflow soldering condition

5. Recommended Reflow soldering condition (SMD)

Solder profile

Peak: 260±5°C Soldering zone: 230°C or more, 30±10s. Pre-heating zone 1: 150 \sim 180°C, 90±30s



Temperature profile for reflow soldering

6. Soldering iron method

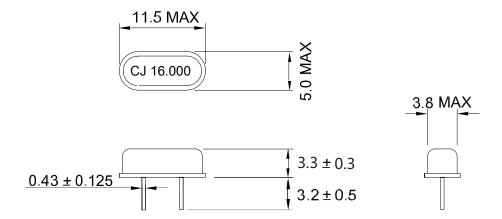
Bit temperature: $350\pm10^{\circ}$ C Application time of soldering iron:3+1 s. For other procedures, refer to IEC 60068-2-20.

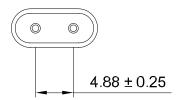
3

rev1.0

Package Outline Dimensions

Units:mm





NOTICE

JSCJ reserve the right to make modifications,enhancements, improvements, corrections or other changes without turther notice to any product herein. JSCJ does not assume any liability arising out of the application or use of any product described herein.

4

rev1.0

X-ON Electronics

Largest Supplier of Electrical and Electronic Components

Click to view similar products for Resonators category:

Click to view products by Changjiang manufacturer:

Other Similar products are found below:

B39431R820H210 ECS-HFR-40.00-B-TR CSTLS4M00G53Z-A0 ECS-CR2-16.00-A-TR ECS-HFR-20.00-B-TR ECS-CR2-20.00-A-TR RO3164E-3 CSTNE14M7V510000R0 AWSCR-4.19CRLB-C15-T3 AWSCR-4.91CRLB-C15-T3 AWSCR-5.00CPLB-C30-T4 CSTNE8M00GH5C060R0 9AC04194152080D2JB CSTCR4M91G55B-R0 CSTLS3M68G56-B0 FC-12M32.768KHZ9PF20PPM 7Y032768NW2 ASR315S2 ASR433.42E-T 146-32.768-12.5-20-20/A ZTA 3.68MG X1A000091000500 X1A0000910001 AWSCR-25.00CW-T AWSZT-12.00MWD-T ECS-SR1-4.19-B-TR 7C024000HW1 7C012000IW1 7C012000MW1 7C016000HW1 7C016000HW1 7C016000HW1 7C024576RW1 X201632MKB4SI 7C027000MW1 7E25000E18UCG 7E50000E18UCG XYCCCLNANF-16.000000MHZ XYDBPCNANF-12MHZ XYDBBCNANF-16.000000MHZ XYDBBCNANF-24.000000MHZ XYHCCLNANF-24.000000MHZ XYBBCLNANF-26.000000MHZ CM4012M00020T8188026